Custom High Performance Cooling Solutions w/ maxiGRIP™ Attachment*

DIGI-KEY PART # ATS1371-ND

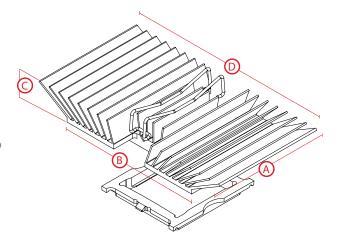
ATS PART # ATS-59006-C2-R0

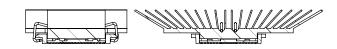
Features & Benefits

Designed for flip-chip processors such as Freescale MPCs

maxiGRIP™ attachment applies steady, even pressure to the component and does not require holes in the PCB

Comes preassembled with high performance, phase changing, thermal interface material





Thermal Performance Table

| AIR VELOCITY | | THERMAL RESISTANCE | | |
|--------------|-----|--------------------|---------------|--|
| FT/MIN | M/S | °C/W (UNDUCTED) | °C/W (DUCTED) | |
| 200 | 1.0 | 6.2 | 3.8 | |
| 300 | 1.5 | 4.9 | | |
| 400 | 2.0 | 4.2 | | |
| 500 | 2.5 | 3.7 | | |
| 600 | 3.0 | 3.3 | | |
| 700 | 3.5 | 3 | | |
| 800 | 4.0 | 2.8 | | |

Product Details†

| DIMENSION A | DIMENSION B | DIMENSION C [§] | DIMENSION D | TIM [‡] | FINISH |
|-------------|-------------|--------------------------|-------------|------------------|----------------|
| 29 | 37 | 11 | 54 | C1100F | BLACK-ANODIZED |

For further technical information, please contact Advanced Thermal Solutions, Inc. at **1-781-769-2800** or **www.qats.com**

- * RoHS Compliant
- ‡ TIM = Thermal Interface Material
- † Dimensions are measured in millimeters
- § Dimension C = the height of the heat sink shown above and does not include the height of the attachment method



